ZHCS750

SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

- V_R = 40V
- I_F = 750mA
- I_R = 50μA

Features and Benefits

- High current capability (I_F = 750mA)
- Low V_F
- **Qualified to AEC-Q101 Standards for High Reliability**

Description and Applications

- DC – DC Converters
- Mobile Telecomms
- PCMIA

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)

SOT23

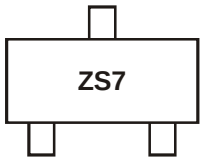
Top View

Ordering Information (Note 1)

Device	Packaging	Shipping
ZHCS750TA	SOT23	3000/Tape & Reel

Notes: 1. For Packaging Details, go to our website at http://www.diodes.com.

Marking Information



ZS7 = Product Type Marking Code

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units
Continuous Reverse Voltage		V_R	40	V
Continuous Forward Current		I_F	750	mA
Forward Voltage @ I_F = 750mA		V_F	490	mV
Average Peak Forward Current; D.C. = 50%		I_{FAV}	1500	mA
Non Repetitive Forward Current	t ≤ 100µs	I_{FSM}	12	A
	t ≤ 10ms		5.2	A

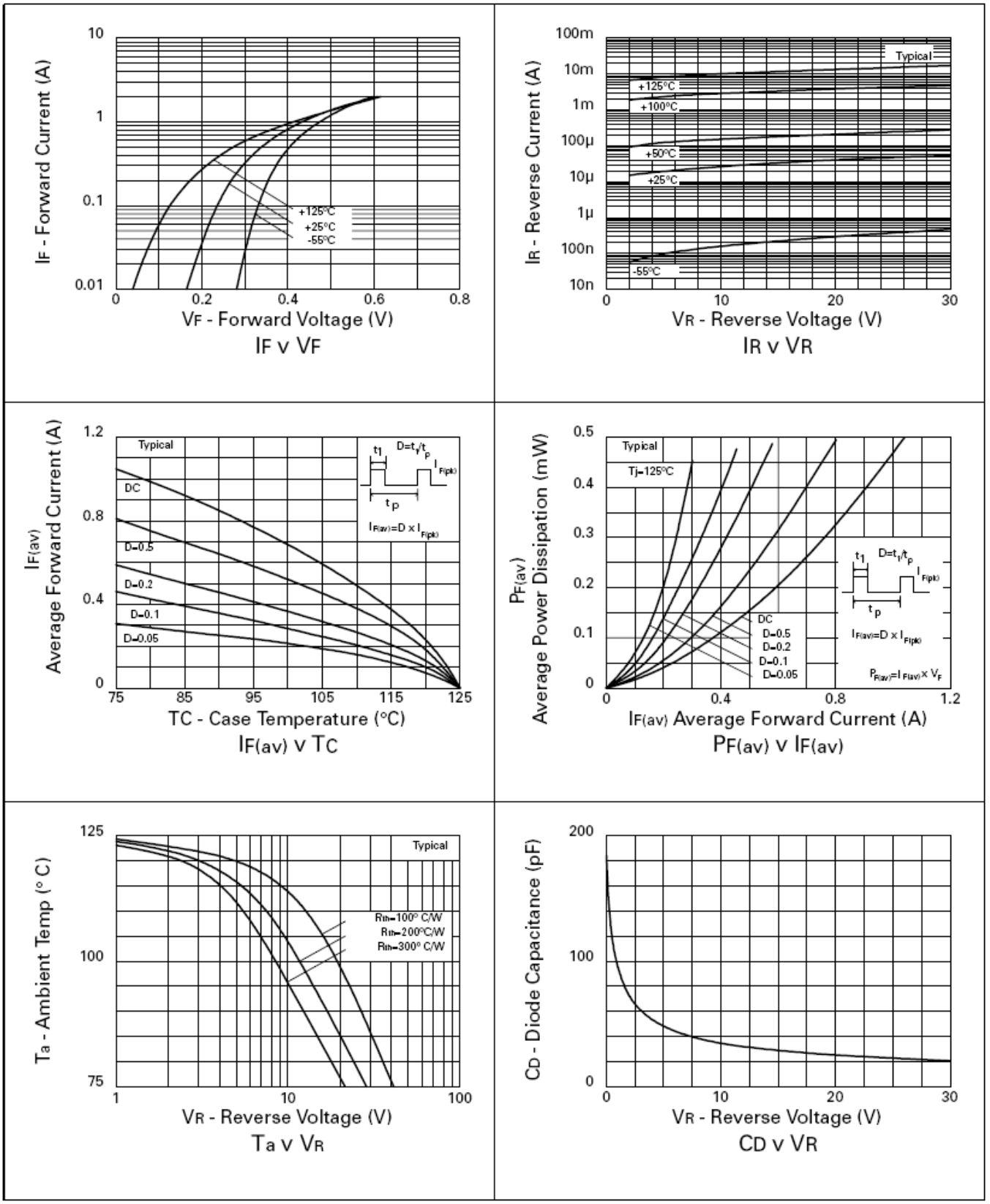
Thermal Characteristics

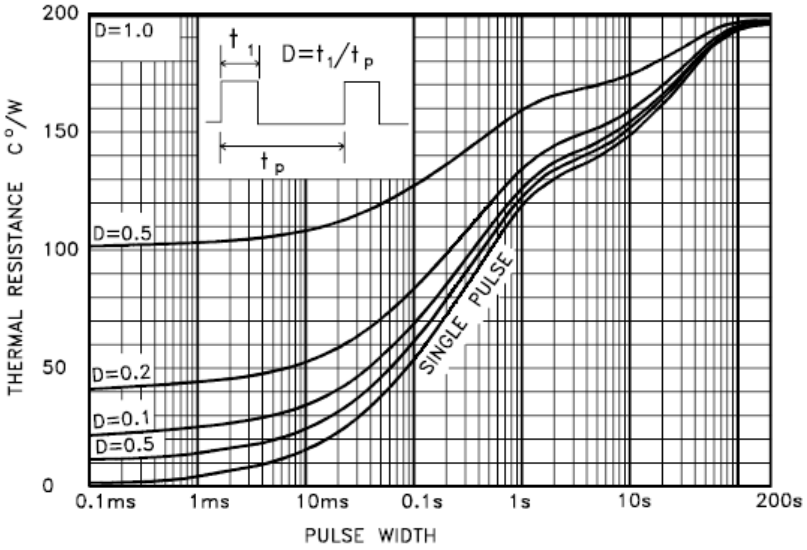
Characteristic	Symbol	Value	Unit
Power Dissipation, T_A = 25°C	P_D	500	mW
Junction Temperature	T_J	125	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	40	60	-	V	I_R = 300µA
Forward Voltage (Note 2)	V_F	-	225	280	mV	I_F = 50mA
		-	235	310		I_F = 100mA
		-	290	350		I_F = 250mA
		-	340	420		I_F = 500mA
		-	390	490		I_F = 750mA
		-	440	540		I_F = 1A
		-	530	650		I_F = 1.5A
Reverse Current	I_R	-	50	100	µA	V_R = 30V
Diode Capacitance	C_D	-	25	-	pF	f = 1MHz, V_R = 25V
Reverse Recovery Time	trr	-	12	-	ns	Switched from I_F = 500mA to I_R = 500mA Measured @ I_R = 50mA

Notes: 2. Measured under pulsed conditions. Pulse width = 300µS. Duty cycle ≤ 2%.

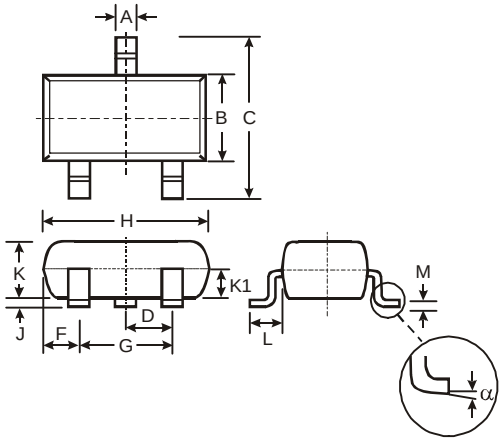




MAXIMUM TRANSIENT THERMAL RESISTANCE*

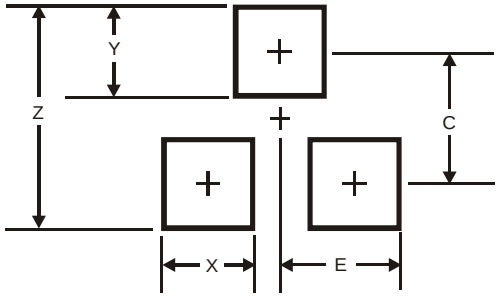
* Reference above figure, devices were mounted on a 15mmx15mm ceramic substrate.

Package Outline Dimensions



SOT23			
Dim	**Min**	**Max**	**Typ**
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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